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[Signature]

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Hideki IWAKI

Application No. 09/994,683

Filed: November 28, 2001

For: MULTI-LEVEL CIRCUIT SUBSTRATE,
METHOD FOR MANUFACTURING
SAME AND METHOD FOR
ADJUSTING A CHARACTERISTIC
IMPEDANCE THEREFOR

Confirmation No. 8158

TC/Art Unit: 2826

Examiner: Leonardo Andujar

Atty Docket: P94916US1

Approved
E. Andujar

LETTER RESPONDING TO COMMUNICATION

MAIL STOP ISSUE FEE

Commissioner for Patents

PO Box 1450

Alexandria, VA 22313-1450

Sir:

In response to the Office Communication dated May 27, 2004, please cancel the sheet of drawings containing Figure 14 and the duplicate copy of Figure 9.